# Designer's™ Data Sheet

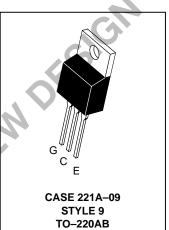
# Insulated Gate Bipolar Transistor with Anti-Parallel Diode N-Channel Enhancement-Mode Silicon Gate

This Insulated Gate Bipolar Transistor (IGBT) is co-packaged with a soft recovery ultra-fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage-blocking capability. Its new 600 V IGBT technology is specifically suited for applications requiring both a high temperature short circuit capability and a low  $V_{CE(on)}$ . It also provides fast switching characteristics and results in efficient operation at high frequencies. Co-packaged IGBTs save space, reduce assembly time and cost. This new E-series introduces an energy efficient, ESD protected and short circuit rugged device.

- Industry Standard TO–220 Package
- High Speed: E<sub>off</sub> = 60 μJ/A typical at 125°C
- High Voltage Short Circuit Capability 10 μs minimum at 125°C, 400 V
- Low On–Voltage 2.0 V typical at 3.0 A, 125°C
- Soft Recovery Free Wheeling Diode
   is Included in the Package
- Robust High Voltage Termination
- ESD Protection Gate-Emitter Zener Diodes



IGBT & DIODE IN TO-220 4.0 A @ 90°C 6.0 A @ 25°C 600 VOLTS SHORT CIRCUIT RATED LOW ON-VOLTAGE



#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit Vdc	
Collector–Emitter Voltage	V <sub>CES</sub>	600		
Collector–Gate Voltage ( $R_{GE} = 1.0 \text{ M}\Omega$ )	V <sub>CGR</sub>	600	Vdc	
Gate-Emitter Voltage — Continuous	V <sub>GE</sub>	±20	Vdc	
Collector Current — Continuous @ $T_C = 25^{\circ}C$ — Continuous @ $T_C = 90^{\circ}C$ — Repetitive Pulsed Current (1)	I <sub>C25</sub> I <sub>C90</sub> I <sub>CM</sub>	6.0 4.0 8.0	Adc Apk	
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	62.5 0.51	Watts W/°C	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C	
Short Circuit Withstand Time ( $V_{CC}$ = 400 Vdc, $V_{GE}$ = 15 Vdc, $T_J$ = 125°C, $R_G$ = 20 $\Omega$ )	t <sub>sc</sub>	10	μs	
Thermal Resistance — Junction to Case – IGBT — Junction to Case – Diode — Junction to Ambient	R <sub>θJC</sub> R <sub>θJC</sub> R <sub>θJA</sub>	2.0 3.6 65	°C/W	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C	
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)			

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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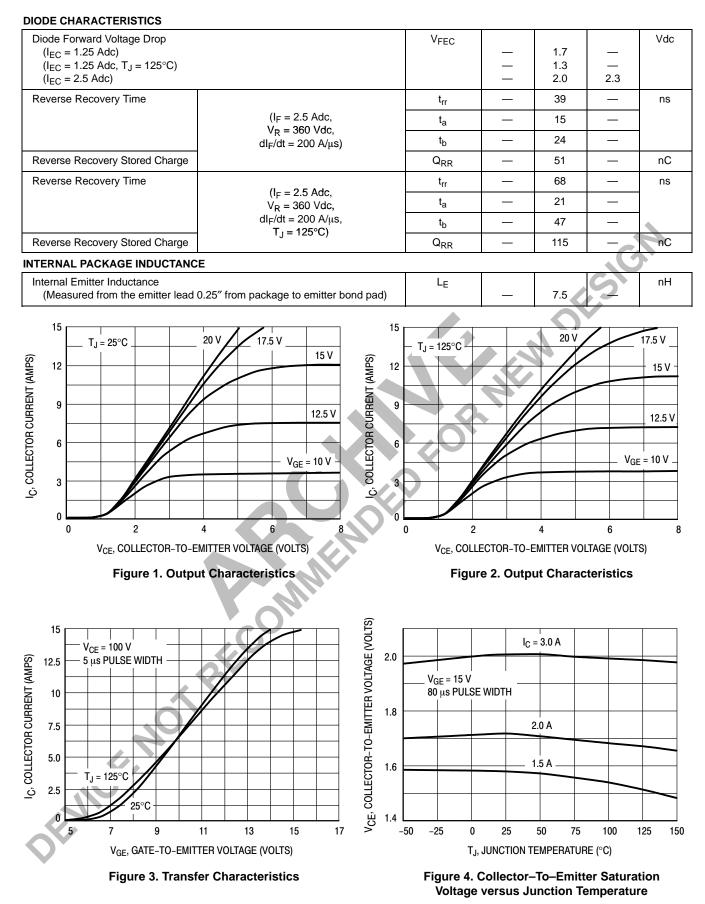


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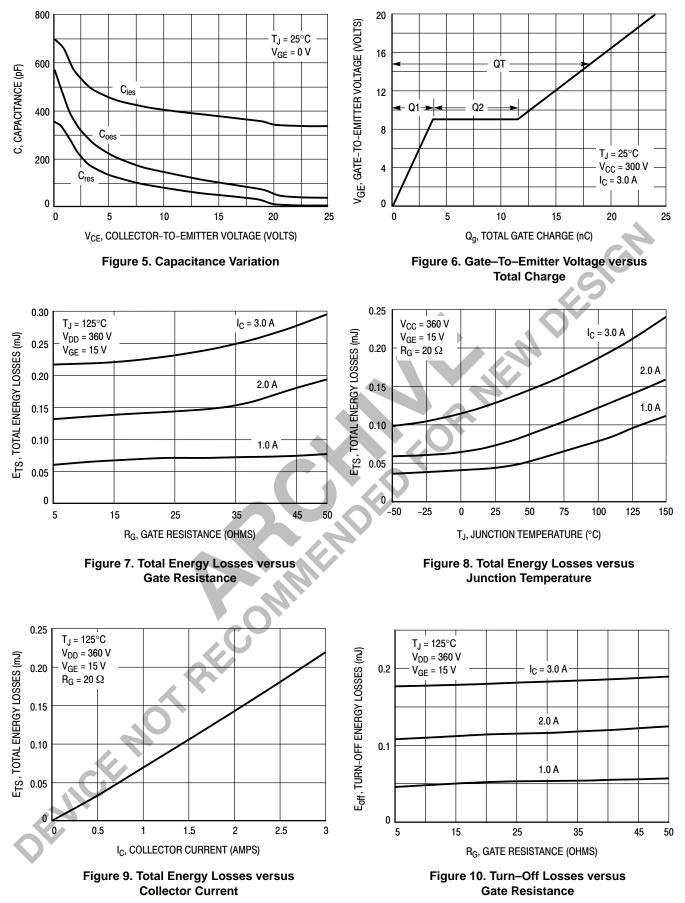
#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

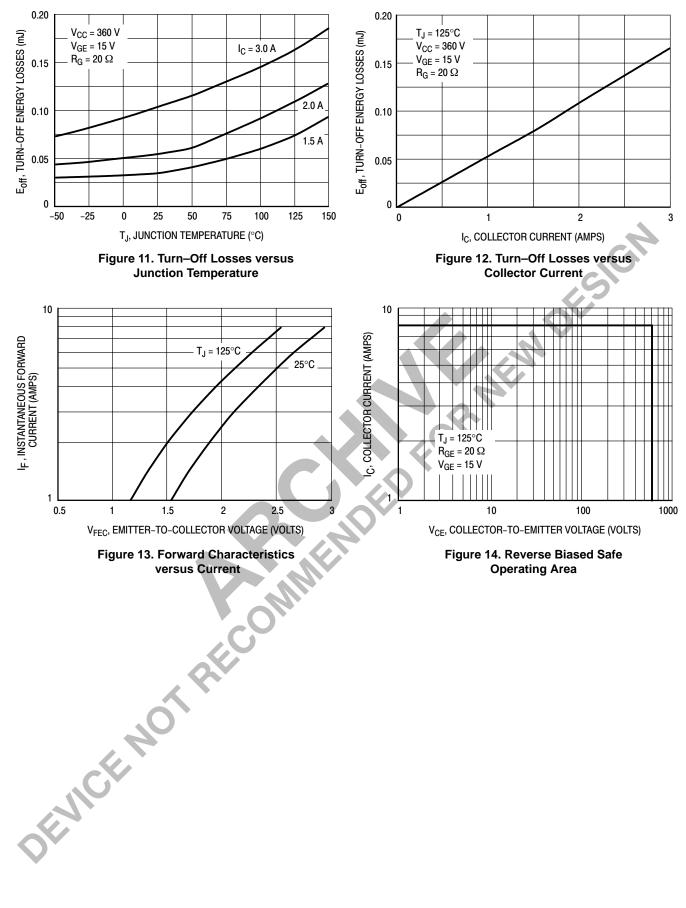
Cha	racteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown V ( $V_{GE} = 0$ Vdc, $I_C = 25 \mu$ Adc) Temperature Coefficient (Positive	0	V <sub>(BR)</sub> CES	600 —	 870		Vdc mV/°C
Zero Gate Voltage Collector Currer ( $V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}$ ) ( $V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}, T_{CE}$		ICES			10 200	μAdc
Gate–Body Leakage Current (V <sub>GE</sub>	= ± 20 Vdc, V <sub>CE</sub> = 0 Vdc)	I <sub>GES</sub>	—	_	50	μAdc
ON CHARACTERISTICS (1)						
$\label{eq:constraint} \begin{array}{l} \mbox{Collector-to-Emitter On-State Volt} \\ (V_{GE}=15 \mbox{ Vdc}, \mbox{ I}_{C}=1.5 \mbox{ Adc}) \\ (V_{GE}=15 \mbox{ Vdc}, \mbox{ I}_{C}=1.5 \mbox{ Adc}, \mbox{ T}_{J}=0.5 \mbox{ Vdc}, \mbox{ I}_{C}=3.0 \mbox{ Adc}) \end{array}$	5	V <sub>CE(on)</sub>		1.6 1.5 2.0	1.9  2.4	Vdc
Gate Threshold Voltage ( $V_{CE} = V_{GE}$ , $I_C = 1.0$ mAdc) Threshold Temperature Coefficie	nt (Negative)	V <sub>GE(th)</sub>	4.0	6.0 10	8.0	Vdc mV/°C
Forward Transconductance (V <sub>CE</sub> =	10 Vdc, I <sub>C</sub> = 3.0 Adc)	9 <sub>fe</sub>	—	1.8	_	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C <sub>ies</sub>	-	342	_	pF
Output Capacitance	(V <sub>CE</sub> = 25 Vdc, V <sub>GE</sub> = 0 Vdc, f = 1.0 MHz)	C <sub>oes</sub>	×	40	_	
Transfer Capacitance		Cres		3.0	_	1
SWITCHING CHARACTERISTICS (	1)				_	
Turn–On Delay Time		t <sub>d(on)</sub>	—	34	_	ns
Rise Time		t <sub>r</sub>	—	30	_	]
Turn–Off Delay Time	$(V_{CC} = 360 \text{ Vdc}, I_C = 3.0 \text{ Adc},$	t <sub>d(off)</sub>	—	36	_	
Fall Time	$V_{GE} = 15 \text{ Vdc}, \text{ L} = 300 \mu\text{H}, \\ \text{R}_{G} = 20 \Omega\text{)}$	t <sub>f</sub>	—	216	_	1
Turn–Off Switching Loss	Energy losses include "tail"	E <sub>off</sub>	—	100	150	μJ
Turn–On Switching Loss		E <sub>on</sub>	—	25	_	
Total Switching Loss		E <sub>ts</sub>	—	125		1
Turn-On Delay Time		t <sub>d(on)</sub>	—	33		ns
Rise Time	(V <sub>CC</sub> = 360 Vdc, I <sub>C</sub> = 3.0 Adc,	t <sub>r</sub>	—	32		
Turn–Off Delay Time		t <sub>d(off)</sub>		56	_	1
Fall Time	V <sub>GE</sub> = 15 Vdc, L = 300 μH, R <sub>G</sub> = 20 Ω, T <sub>J</sub> = 125°C)	t <sub>f</sub>	_	340	_	1
Turn–Off Switching Loss	Energy losses include "tail"	E <sub>off</sub>		170	—	μJ
Turn–On Switching Loss		E <sub>on</sub>	—	50		1
Total Switching Loss		E <sub>ts</sub>	_	220		1
Gate Charge		QT	—	18.1		nC
	(V <sub>CC</sub> = 360 Vdc, I <sub>C</sub> = 3.0 Adc, V <sub>GE</sub> = 15 Vdc)	Q <sub>1</sub>	—	3.8		1
		Q <sub>2</sub>		7.8	_	1

(1) Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

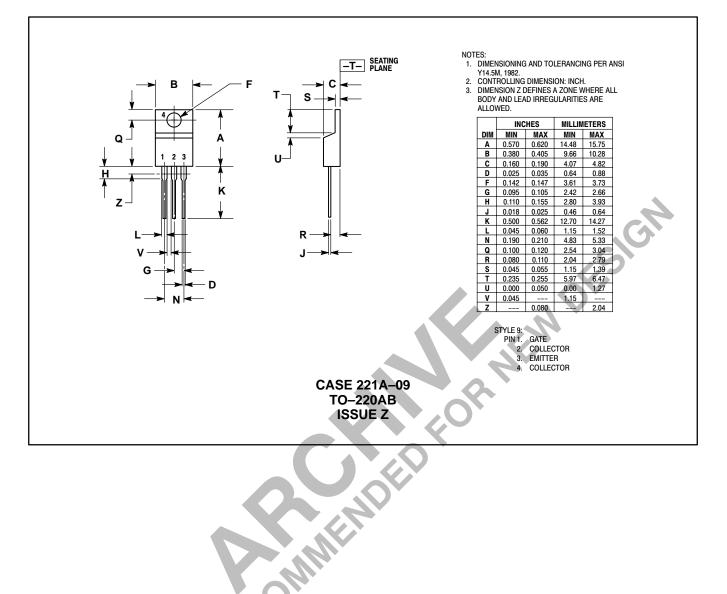


Motorola IGBT Device Data





#### PACKAGE DIMENSIONS



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